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[Embedded - System On Chip \(SoC\): The Heart of Modern Embedded Systems](#)

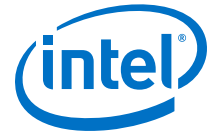
[Embedded - System On Chip \(SoC\)](#) refers to an integrated circuit that consolidates all the essential components of a computer system into a single chip. This includes a microprocessor, memory, and other peripherals, all packed into one compact and efficient package. SoCs are designed to provide a complete computing solution, optimizing both space and power consumption, making them ideal for a wide range of embedded applications.

What are [Embedded - System On Chip \(SoC\)](#)?

System On Chip (SoC) integrates multiple functions of a computer or electronic system onto a single chip. Unlike traditional multi-chip solutions, SoCs combine a central

Details

Product Status	Active
Architecture	MCU, FPGA
Core Processor	Quad ARM® Cortex®-A53 MPCore™ with CoreSight™
Flash Size	-
RAM Size	256KB
Peripherals	DMA, WDT
Connectivity	EBI/EMI, Ethernet, I ² C, MMC/SD/SDIO, SPI, UART/USART, USB OTG
Speed	1.5GHz
Primary Attributes	FPGA - 2800K Logic Elements
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	2912-BBGA, FCBGA
Supplier Device Package	2912-FBGA, FC (55x55)
Purchase URL	https://www.e-xfl.com/product-detail/intel/1sx280lh3f55i1vg



Common to all Intel Stratix 10 family variants is a high-performance fabric based on the new HyperFlex core architecture that includes additional Hyper-Registers throughout the interconnect routing and at the inputs of all functional blocks. The core fabric also contains an enhanced logic array utilizing Intel's adaptive logic module (ALM) and a rich set of high performance building blocks including:

- M20K (20 kbit) embedded memory blocks
- Variable precision DSP blocks with hard IEEE 754 compliant floating-point units
- Fractional synthesis and integer PLLs
- Hard memory controllers and PHY for external memory interfaces
- General purpose IO cells

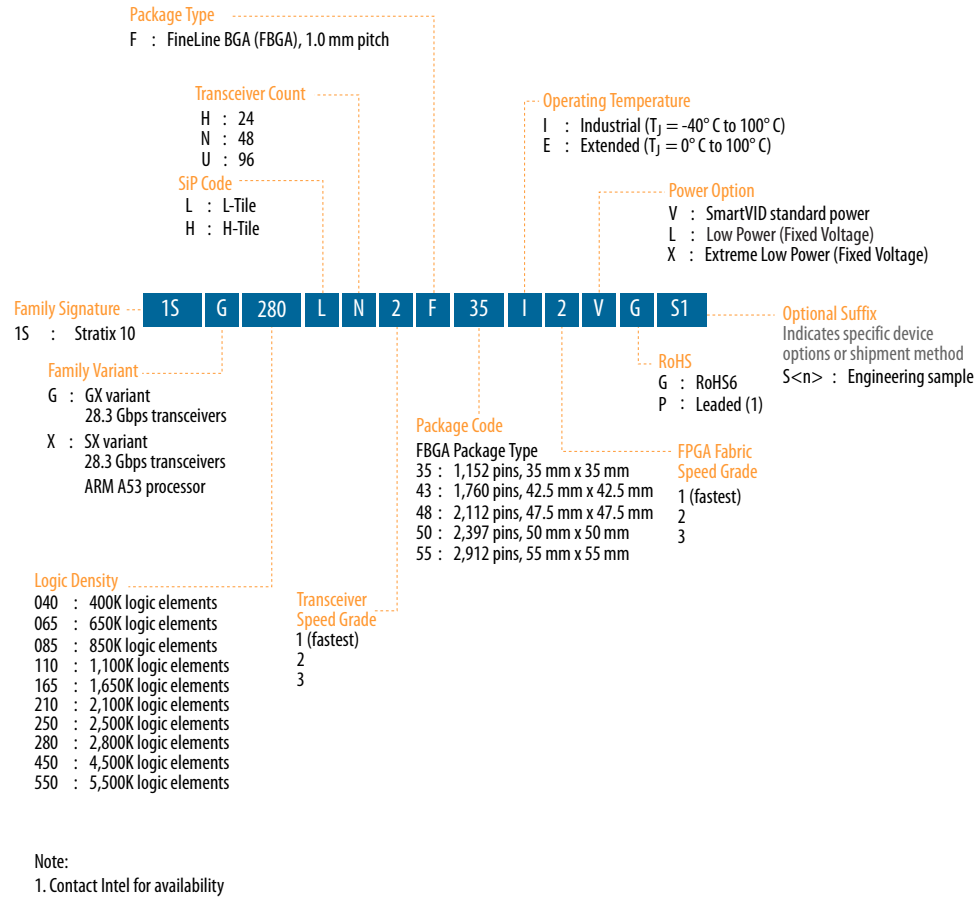
To clock these building blocks, Intel Stratix 10 devices use programmable clock tree synthesis, which uses dedicated clock tree routing to synthesize only those branches of the clock trees required for the application. All devices support in-system, fine-grained partial reconfiguration of the logic array, allowing logic to be added and subtracted from the system while it is operating.

All family variants also contain high speed serial transceivers, containing both the physical medium attachment (PMA) and the physical coding sublayer (PCS), which can be used to implement a variety of industry standard and proprietary protocols. In addition to the hard PCS, Intel Stratix 10 devices contain multiple instantiations of PCI Express hard IP that supports Gen1/Gen2/Gen3 rates in x1/x2/x4/x8/x16 lane configurations, and hard 10GBASE-KR/40GBASE-KR4 FEC for every transceiver. The hard PCS, FEC, and PCI Express IP free up valuable core logic resources, save power, and increase your productivity.



1.1.1. Available Options

Figure 1. Sample Ordering Code and Available Options for Intel Stratix 10 Devices



1.2. Innovations in Intel Stratix 10 FPGAs and SoCs

Intel Stratix 10 FPGAs and SoCs deliver many significant improvements over the previous generation high-performance Stratix V FPGAs.

Table 1. Key Features of Intel Stratix 10 Devices Compared to Stratix V Devices

Feature	Stratix V FPGAs	Intel Stratix 10 FPGAs and SoCs
Process technology	28-nm TSMC (planar transistor)	14 nm Intel Tri-Gate (FinFET)
Hard processor core	None	Quad-core 64-bit ARM Cortex-A53 (SoC only)
Core architecture	Conventional core architecture with conventional interconnect	HyperFlex core architecture with Hyper-Registers in the interconnect
Core performance	500 MHz	1 GHz
Power dissipation	1x	As low as 0.3x
<i>continued...</i>		



- **Additional Hard IP:** Intel Stratix 10 devices include many more hard IP blocks than previous generation devices, with a hard memory controller included in each bank of 48 general purpose IOs, a hard PCIe Gen3 x16 full protocol stack in each transceiver tile, and a hard 10GBASE-KR/40GBASE-KR4 FEC in every transceiver channel
- **Enhanced Core Clocking:** Intel Stratix 10 devices feature programmable clock tree synthesis; clock trees are only synthesized where needed, increasing the flexibility and reducing the power dissipation of the clocking solution
- **Additional Core PLLs:** The core fabric in Intel Stratix 10 devices is supported by both integer IO PLLs and fractional synthesis fPLLs, resulting in a greater total number of PLLs available than the previous generation

1.3. FPGA and SoC Features Summary

Table 2. Intel Stratix 10 FPGA and SoC Common Device Features

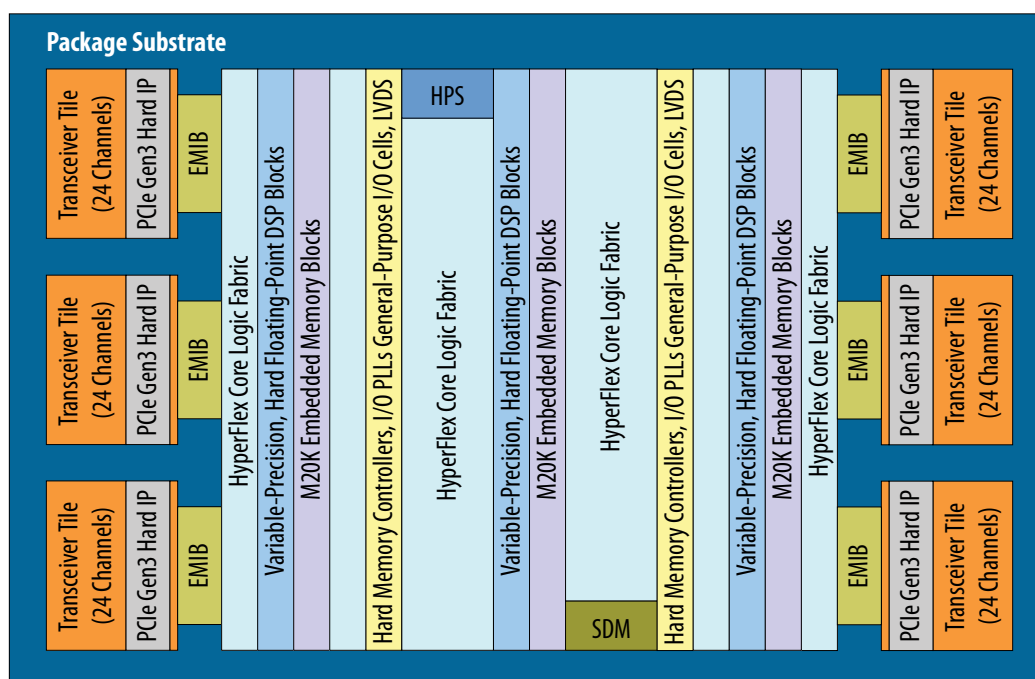
Feature	Description
Technology	<ul style="list-style-type: none">• 14-nm Intel Tri-Gate (FinFET) process technology• SmartVID controlled core voltage, standard power devices• 0.85-V fixed core voltage, low static power devices available
Low power serial transceivers	<ul style="list-style-type: none">• Up to 96 total transceivers available• Continuous operating range of 1 Gbps to 28.3 Gbps for Intel Stratix 10 GX/SX devices• Backplane support up to 28.3 Gbps for Intel Stratix 10 GX/SX devices• Extended range down to 125 Mbps with oversampling• ATX transmit PLLs with user-configurable fractional synthesis capability• XFP, SFP+, QSFP/QSFP28, CFP/CFP2/CFP4 optical module support• Adaptive linear and decision feedback equalization• Transmit pre-emphasis and de-emphasis• Dynamic partial reconfiguration of individual transceiver channels• On-chip instrumentation (Eye Viewer non-intrusive data eye monitoring)
General purpose I/Os	<ul style="list-style-type: none">• Up to 1640 total GPIO available• 1.6 Gbps LVDS—every pair can be configured as an input or output• 1333 MHz/2666 Mbps DDR4 external memory interface• 1067 MHz/2133 Mbps DDR3 external memory interface• 1.2 V to 3.0 V single-ended LVCMOS/LVTTL interfacing• On-chip termination (OCT)
Embedded hard IP	<ul style="list-style-type: none">• PCIe Gen1/Gen2/Gen3 complete protocol stack, x1/x2/x4/x8/x16 end point and root port• DDR4/DDR3/LPDDR3 hard memory controller (RLDRAM3/QDR II+/QDR IV using soft memory controller)• Multiple hard IP instantiations in each device• Single Root I/O Virtualization (SR-IOV)
Transceiver hard IP	<ul style="list-style-type: none">• 10GBASE-KR/40GBASE-KR4 Forward Error Correction (FEC)• 10G Ethernet PCS• PCI Express PIPE interface• Interlaken PCS• Gigabit Ethernet PCS• Deterministic latency support for Common Public Radio Interface (CPRI) PCS• Fast lock-time support for Gigabit Passive Optical Networking (GPON) PCS• 8B/10B, 64B/66B, 64B/67B encoders and decoders• Custom mode support for proprietary protocols
continued...	



SoC Subsystem	Feature	Description
	NAND flash controller	<ul style="list-style-type: none"> 1 ONFI 1.0, 8- and 16-bit support
	General-purpose I/O (GPIO)	<ul style="list-style-type: none"> Maximum of 48 software programmable GPIO
	Timers	<ul style="list-style-type: none"> 4 general-purpose timers 4 watchdog timers
Secure Device Manager	Security	<ul style="list-style-type: none"> Secure boot Advanced Encryption Standard (AES) and authentication (SHA/ECDSA)
External Memory Interface	External Memory Interface	<ul style="list-style-type: none"> Hard Memory Controller with DDR4 and DDR3, and LPDDR3

1.4. Intel Stratix 10 Block Diagram

Figure 2. Intel Stratix 10 FPGA and SoC Architecture Block Diagram



HPS: Quad ARM Cortex-A53 Hard Processor System

SDM: Secure Device Manager

EMIB: Embedded Multi-Die Interconnect Bridge

1.5. Intel Stratix 10 FPGA and SoC Family Plan

⁽¹⁾ The number of 27x27 multipliers is one-half the number of 18x19 multipliers.



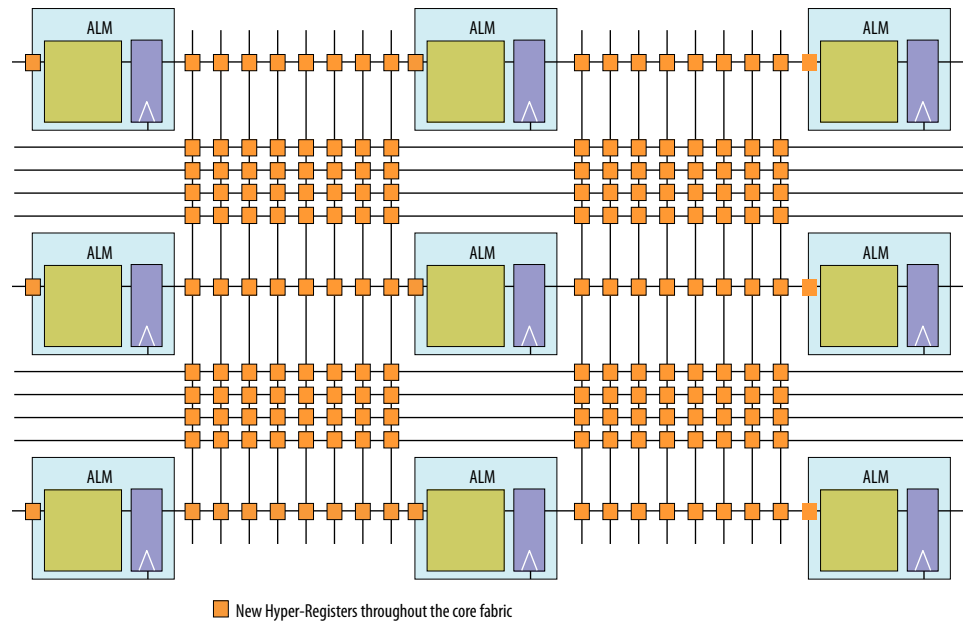
Table 4. Intel Stratix 10 GX/SX FPGA and SoC Family Plan—FPGA Core (part 1)

Intel Stratix 10 GX/SX Device Name	Logic Elements (KLE)	M20K Blocks	M20K Mbits	MLAB Counts	MLAB Mbits	18x19 Multipliers ⁽¹⁾
GX 400/ SX 400	378	1,537	30	3,204	2	1,296
GX 650/ SX 650	612	2,489	49	5,184	3	2,304
GX 850/ SX 850	841	3,477	68	7,124	4	4,032
GX 1100/ SX 1100	1,092	4,401	86	9,540	6	5,040
GX 1650/ SX 1650	1,624	5,851	114	13,764	8	6,290
GX 2100/ SX 2100	2,005	6,501	127	17,316	11	7,488
GX 2500/ SX 2500	2,422	9,963	195	20,529	13	10,022
GX 2800/ SX 2800	2,753	11,721	229	23,796	15	11,520
GX 4500/ SX 4500	4,463	7,033	137	37,821	23	3,960
GX 5500/ SX 5500	5,510	7,033	137	47,700	29	3,960

Table 5. Intel Stratix 10 GX/SX FPGA and SoC Family Plan—Interconnects, PLLs and Hard IP (part 2)

Intel Stratix 10 GX/SX Device Name	Interconnects		PLLs		Hard IP
	Maximum GPIOs	Maximum XCVR	fPLLs	I/O PLLs	PCIe Hard IP Blocks
GX 400/ SX 400	392	24	8	8	1
GX 650/ SX 650	400	48	16	8	2
GX 850/ SX 850	736	48	16	15	2
GX 1100/ SX 1100	736	48	16	15	2
GX 1650/ SX 1650	704	96	32	14	4
GX 2100/ SX 2100	704	96	32	14	4
GX 2500/ SX 2500	1160	96	32	24	4
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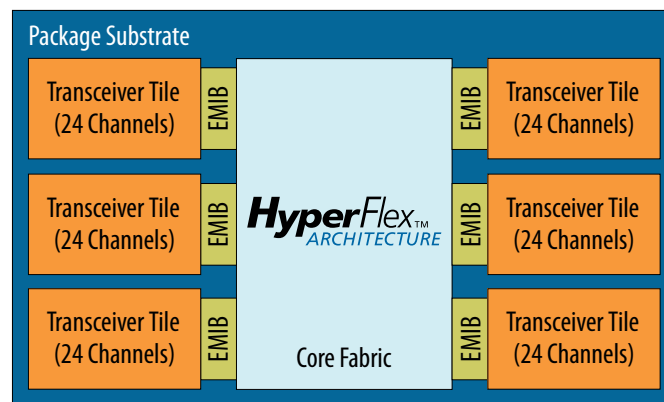
Figure 4. HyperFlex Core Architecture

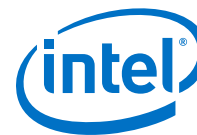


1.7. Heterogeneous 3D SiP Transceiver Tiles

Intel Stratix 10 FPGAs and SoCs feature power efficient, high bandwidth, low latency transceivers. The transceivers are implemented on heterogeneous 3D System-in-Package (SiP) transceiver tiles, each containing 24 full-duplex transceiver channels. In addition to providing a high-performance transceiver solution to meet current connectivity needs, this allows for future flexibility and scalability as data rates, modulation schemes, and protocol IPs evolve.

Figure 5. Monolithic Core Fabric and Heterogeneous 3D SiP Transceiver Tiles

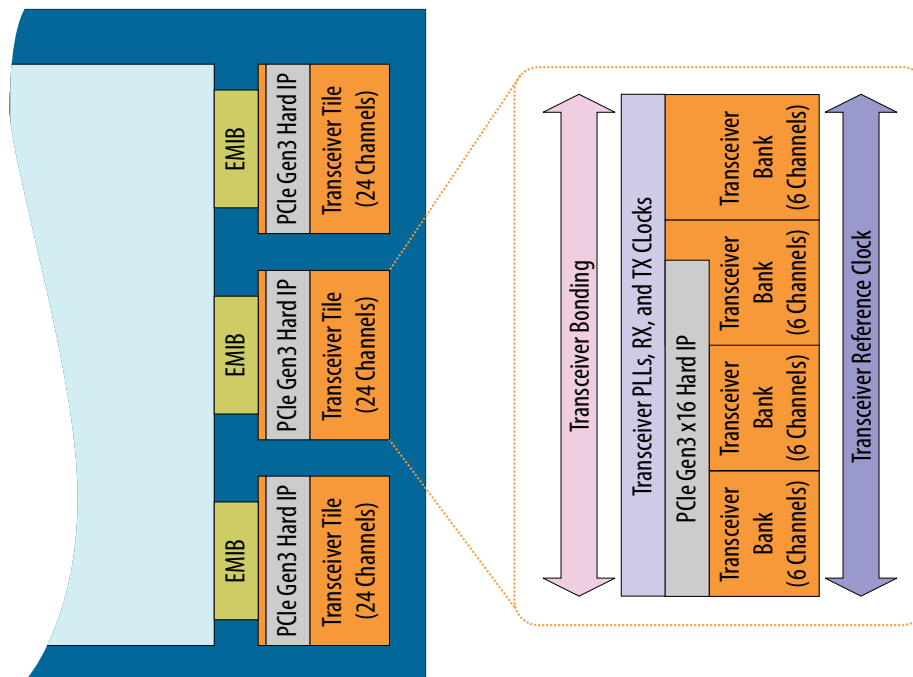




Each transceiver tile contains:

- 24 full-duplex transceiver channels (PMA and PCS)
- Reference clock distribution network
- Transmit PLLs
- High-speed clocking and bonding networks
- One instance of PCI Express hard IP

Figure 6. Heterogeneous 3D SiP Transceiver Tile Architecture

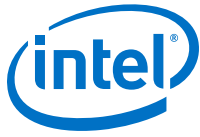


1.8. Intel Stratix 10 Transceivers

Intel Stratix 10 devices offer up to 96 total full-duplex transceiver channels. These channels provide continuous data rates from 1 Gbps to 28.3 Gbps for chip-to-chip, chip-to-module, and backplane applications. In each device, two thirds of the transceivers can be configured up to the maximum data rate of 28.3 Gbps to drive 100G interfaces and C form-factor pluggable CFP2/CFP4 optical modules. For longer-reach backplane driving applications, advanced adaptive equalization circuits are used to equalize over 30 dB of system loss.

All transceiver channels feature a dedicated Physical Medium Attachment (PMA) and a hardened Physical Coding Sublayer (PCS).

- The PMA provides primary interfacing capabilities to physical channels.
- The PCS typically handles encoding/decoding, word alignment, and other pre-processing functions before transferring data to the FPGA core fabric.



Within each transceiver tile, the transceivers are arranged in four banks of six PMA-PCS groups. A wide variety of bonded and non-bonded data rate configurations are possible within each bank, and within each tile, using a highly configurable clock distribution network.

1.8.1. PMA Features

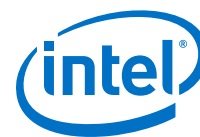
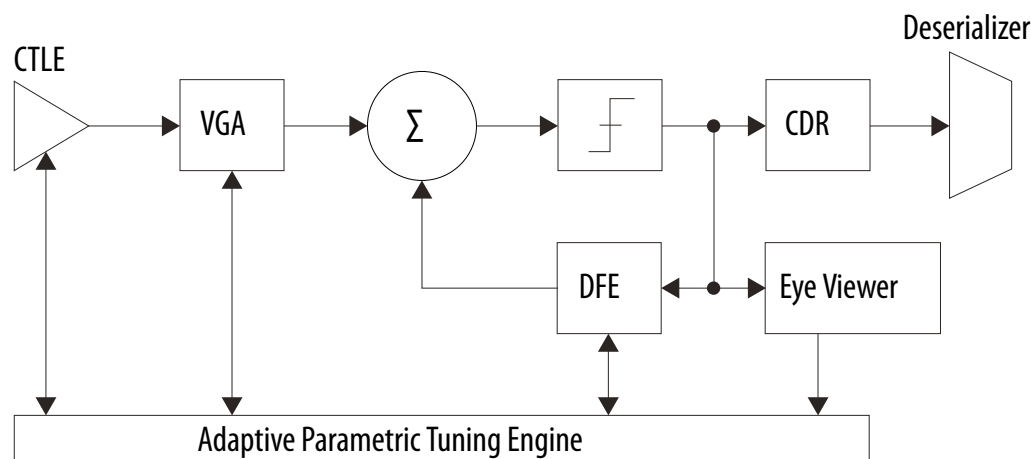
PMA channels are comprised of transmitter (TX), receiver (RX), and high speed clocking resources.

Intel Stratix 10 device features provide exceptional signal integrity at data rates up to 28.3 Gbps. Clocking options include ultra-low jitter LC tank-based (ATX) PLLs with optional fractional synthesis capability, channel PLLs operating as clock multiplier units (CMUs), and fractional synthesis PLLs (fPLLs).

- **ATX PLL**—can be configured in integer mode, or optionally, in a new fractional synthesis mode. Each ATX PLL spans the full frequency range of the supported data rate range providing a stable, flexible clock source with the lowest jitter.
- **CMU PLL**—when not being used as a transceiver, select PMA channels can be configured as channel PLLs operating as CMUs to provide an additional master clock source within the transceiver bank.
- **fPLL**—In addition, dedicated fPLLs are available with precision frequency synthesis capabilities. fPLLs can be used to synthesize multiple clock frequencies from a single reference clock source and replace multiple reference oscillators for multi-protocol and multi-rate applications.

On the receiver side, each PMA has an independent channel PLL that allows analog tracking for clock-data recovery. Each PMA also has advanced equalization circuits that compensate for transmission losses across a wide frequency spectrum.

- **Variable Gain Amplifier (VGA)**—to optimize the receiver's dynamic range
- **Continuous Time Linear Equalizer (CTLE)**—to compensate for channel losses with lowest power dissipation
- **Decision Feedback Equalizer (DFE)**—to provide additional equalization capability on backplanes even in the presence of crosstalk and reflections
- **On-Die Instrumentation (ODI)**—to provide on-chip eye monitoring capabilities (Eye Viewer). This capability helps to optimize link equalization parameters during board bring-up and supports in-system link diagnostics and equalization margin testing

**Figure 7. Intel Stratix 10 Receiver Block Features**

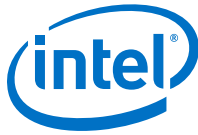
All link equalization parameters feature automatic adaptation using the new Advanced Digital Adaptive Parametric Tuning (ADAPT) circuit. This circuit is used to dynamically set DFE tap weights, adjust CTLE parameters, and optimize VGA gain and threshold voltage. Finally, optimal and consistent signal integrity is ensured by using the new hardened Precision Signal Integrity Calibration Engine (PreSICE) to automatically calibrate all transceiver circuit blocks on power-up. This gives the most link margin and ensures robust, reliable, and error-free operation.

Table 8. Transceiver PMA Features

Feature	Capability
Chip-to-Chip Data Rates	1 Gbps ⁽⁸⁾ to 28.3 Gbps (Intel Stratix 10 GX/SX devices)
Backplane Support	Drive backplanes at data rates up to 28.3 Gbps, including 10GBASE-KR compliance
Optical Module Support	SFP+/SFP, XFP, CXP, QSFP/QSFP28, QSFPDD, CFP/CFP2/CFP4
Cable Driving Support	SFP+ Direct Attach, PCI Express over cable, eSATA
Transmit Pre-Emphasis	5-tap transmit pre-emphasis and de-emphasis to compensate for system channel loss
Continuous Time Linear Equalizer (CTLE)	Dual mode, high-gain, and high-data rate, linear receive equalization to compensate for system channel loss
Decision Feedback Equalizer (DFE)	15 fixed tap DFE to equalize backplane channel loss in the presence of crosstalk and noisy environments
Advanced Digital Adaptive Parametric Tuning (ADAPT)	Fully digital adaptation engine to automatically adjust all link equalization parameters—including CTLE, DFE, and VGA blocks—that provide optimal link margin without intervention from user logic
Precision Signal Integrity Calibration Engine (PreSICE)	Hardened calibration controller to quickly calibrate all transceiver control parameters on power-up, which provides the optimal signal integrity and jitter performance
ATX Transmit PLLs	Low jitter ATX (inductor-capacitor) transmit PLLs with continuous tuning range to cover a wide range of standard and proprietary protocols, with optional fractional frequency synthesis capability
Fractional PLLs	On-chip fractional frequency synthesizers to replace on-board crystal oscillators and reduce system cost

continued...

⁽⁸⁾ Stratix 10 transceivers can support data rates below 1 Gbps with over sampling.



Feature	Capability
Digitally Assisted Analog CDR	Superior jitter tolerance with fast lock time
On-Die Instrumentation—Eye Viewer and Jitter Margin Tool	Simplify board bring-up, debug, and diagnostics with non-intrusive, high-resolution eye monitoring (Eye Viewer). Also inject jitter from transmitter to test link margin in system.
Dynamic Reconfiguration	Allows for independent control of each transceiver channel Avalon memory-mapped interface for the most transceiver flexibility.
Multiple PCS-PMA and PCS-Core to FPGA fabric interface widths	8-, 10-, 16-, 20-, 32-, 40-, or 64-bit interface widths for flexibility of deserialization width, encoding, and reduced latency

1.8.2. PCS Features

Intel Stratix 10 PMA channels interface with core logic through configurable and bypassable PCS interface layers.

The PCS contains multiple gearbox implementations to decouple the PMA and PCS interface widths. This feature provides the flexibility to implement a wide range of applications with 8, 10, 16, 20, 32, 40, or 64-bit interface width between each transceiver and the core logic.

The PCS also contains hard IP to support a variety of standard and proprietary protocols across a wide range of data rates and encoding schemes. The Standard PCS mode provides support for 8B/10B encoded applications up to 12.5 Gbps. The Enhanced PCS mode supports 64B/66B and 64B/67B encoded applications up to 17.4 Gbps. The enhanced PCS mode also includes an integrated 10GBASE-KR/40GBASE-KR4 Forward Error Correction (FEC) circuit. For highly customized implementations, a PCS Direct mode provides an interface up to 64 bits wide to allow for custom encoding and support for data rates up to 28.3 Gbps.

For more information about the PCS-Core interface or the double rate transfer mode, refer to the *Intel Stratix 10 L- and H-Tile Transceiver PHY User Guide*, and the *Intel Stratix 10 E-Tile Transceiver PHY User Guide*.

Table 9. Transceiver PCS Features

PCS Protocol Support	Data Rate (Gbps)	Transmitter Data Path	Receiver Data Path
Standard PCS	1 to 12.5	Phase compensation FIFO, byte serializer, 8B/10B encoder, bit-slipper, channel bonding	Rate match FIFO, word-aligner, 8B/10B decoder, byte deserializer, byte ordering
PCI Express Gen1/Gen2 x1, x2, x4, x8, x16	2.5 and 5.0	Same as Standard PCS plus PIPE 2.0 interface to core	Same as Standard PCS plus PIPE 2.0 interface to core
PCI Express Gen3 x1, x2, x4, x8, x16	8.0	Phase compensation FIFO, byte serializer, encoder, scrambler, bit-slipper, gear box, channel bonding, and PIPE 3.0 interface to core, auto speed negotiation	Rate match FIFO (0-600 ppm mode), word-aligner, decoder, descrambler, phase compensation FIFO, block sync, byte deserializer, byte ordering, PIPE 3.0 interface to core, auto speed negotiation
CPRI	0.6144 to 9.8	Same as Standard PCS plus deterministic latency serialization	Same as Standard PCS plus deterministic latency deserialization
continued...			



PCS Protocol Support	Data Rate (Gbps)	Transmitter Data Path	Receiver Data Path
Enhanced PCS	2.5 to 17.4	FIFO, channel bonding, bit-slipper, and gear box	FIFO, block sync, bit-slipper, and gear box
10GBASE-R	10.3125	FIFO, 64B/66B encoder, scrambler, FEC, and gear box	FIFO, 64B/66B decoder, descrambler, block sync, FEC, and gear box
Interlaken	4.9 to 17.4	FIFO, channel bonding, frame generator, CRC-32 generator, scrambler, disparity generator, bit-slipper, and gear box	FIFO, CRC-32 checker, frame sync, descrambler, disparity checker, block sync, and gear box
SFI-S/SFI-5.2	11.3	FIFO, channel bonding, bit-slipper, and gear box	FIFO, bit-slipper, and gear box
IEEE 1588	1.25 to 10.3125	FIFO (fixed latency), 64B/66B encoder, scrambler, and gear box	FIFO (fixed latency), 64B/66B decoder, descrambler, block sync, and gear box
SDI	up to 12.5	FIFO and gear box	FIFO, bit-slipper, and gear box
GigE	1.25	Same as Standard PCS plus GigE state machine	Same as Standard PCS plus GigE state machine
PCS Direct	up to 28.3	Custom	Custom

Related Information

[Intel Stratix 10 L- and H-Tile Transceiver PHY User Guide](#)

1.9. PCI Express Gen1/Gen2/Gen3 Hard IP

Intel Stratix 10 devices contain embedded PCI Express hard IP designed for performance, ease-of-use, increased functionality, and designer productivity.

The PCI Express hard IP consists of the PHY, Data Link, and Transaction layers. It also supports PCI Express Gen1/Gen2/Gen3 end point and root port, in x1/x2/x4/x8/x16 lane configurations. The PCI Express hard IP is capable of operating independently from the core logic (autonomous mode). This feature allows the PCI Express link to power up and complete link training in less than 100 ms, while the rest of the device is still in the process of being configured. The hard IP also provides added functionality, which makes it easier to support emerging features such as Single Root I/O Virtualization (SR-IOV) and optional protocol extensions.

The PCI Express hard IP has improved end-to-end data path protection using Error Checking and Correction (ECC). In addition, the hard IP supports configuration of the device via protocol (CvP) across the PCI Express bus at Gen1/Gen2/Gen3 rates.

1.10. Interlaken PCS Hard IP

Intel Stratix 10 devices have integrated Interlaken PCS hard IP supporting rates up to 17.4 Gbps per lane.

The Interlaken PCS hard IP is based on the proven functionality of the PCS developed for Intel's previous generation FPGAs, which has demonstrated interoperability with Interlaken ASSP vendors and third-party IP suppliers. The Interlaken PCS hard IP is present in every transceiver channel in Intel Stratix 10 devices.

1.11. 10G Ethernet Hard IP

Intel Stratix 10 devices include IEEE 802.3 10-Gbps Ethernet (10GbE) compliant 10GBASE-R PCS and PMA hard IP. The scalable 10GbE hard IP supports multiple independent 10GbE ports while using a single PLL for all the 10GBASE-R PCS instantiations, which saves on core logic resources and clock networks.

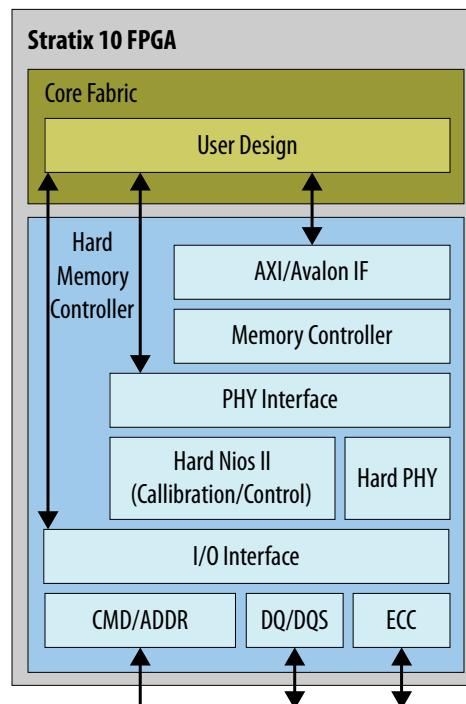
The integrated serial transceivers simplify multi-port 10GbE systems compared to 10 GbE Attachment Unit Interface (XAUI) interfaces that require an external XAUI-to-10G PHY. Furthermore, the integrated transceivers incorporate signal conditioning circuits, which enable direct connection to standard 10G XFP and SFP+ pluggable optical modules. The transceivers also support backplane Ethernet applications and include a hard 10GBASE-KR/40GBASE-KR4 Forward Error Correction (FEC) circuit that can be used for both 10G and 40G applications. The integrated 10G Ethernet hard IP and 10G transceivers save external PHY cost, board space and system power. The 10G Ethernet PCS hard IP and 10GBASE-KR FEC are present in every transceiver channel.

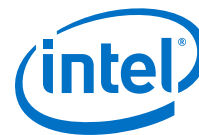
1.12. External Memory and General Purpose I/O

Intel Stratix 10 devices offer substantial external memory bandwidth, with up to ten 72-bit wide DDR4 memory interfaces running at up to 2666 Mbps.

This bandwidth is provided along with the ease of design, lower power, and resource efficiencies of hardened high-performance memory controllers. The external memory interfaces can be configured up to a maximum width of 144 bits when using either hard or soft memory controllers.

Figure 8. Hard Memory Controller





Each I/O bank contains 48 general purpose I/Os and a high-efficiency hard memory controller capable of supporting many different memory types, each with different performance capabilities. The hard memory controller is also capable of being bypassed and replaced by a soft controller implemented in the user logic. The I/Os each have a hardened double data rate (DDR) read/write path (PHY) capable of performing key memory interface functionality such as:

- Read/write leveling
- FIFO buffering to lower latency and improve margin
- Timing calibration
- On-chip termination

The timing calibration is aided by the inclusion of hard microcontrollers based on Intel's Nios® II technology, specifically tailored to control the calibration of multiple memory interfaces. This calibration allows the Intel Stratix 10 device to compensate for any changes in process, voltage, or temperature either within the Intel Stratix 10 device itself, or within the external memory device. The advanced calibration algorithms ensure maximum bandwidth and robust timing margin across all operating conditions.

Table 10. External Memory Interface Performance

The listed speeds are for the 1-rank case.

Interface	Controller Type	Performance
DDR4	Hard	2666 Mbps
DDR3	Hard	2133 Mbps
QDRII+	Soft	1,100 Mtps
QDRII+ Xtreme	Soft	1,266 Mtps
QDRIV	Soft	2,133 Mtps
RLDRAM III	Soft	2400 Mbps
RLDRAM II	Soft	533 Mbps

In addition to parallel memory interfaces, Intel Stratix 10 devices support serial memory technologies such as the Hybrid Memory Cube (HMC). The HMC is supported by the Intel Stratix 10 high-speed serial transceivers, which connect up to four HMC links, with each link running at data rates of 15 Gbps (HMC short reach specification).

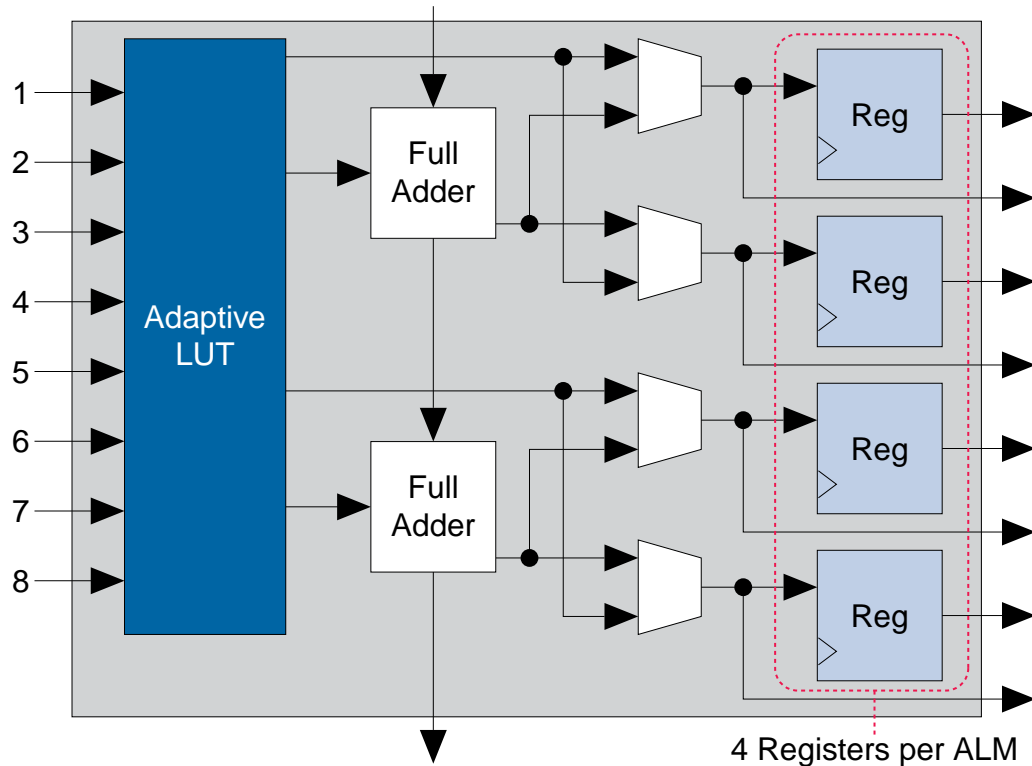
Intel Stratix 10 devices also feature general purpose I/Os capable of supporting a wide range of single-ended and differential I/O interfaces. LVDS rates up to 1.6 Gbps are supported, with each pair of pins having both a differential driver and a differential input buffer. This enables configurable direction for each LVDS pair.

1.13. Adaptive Logic Module (ALM)

Intel Stratix 10 devices use a similar adaptive logic module (ALM) as the previous generation Arria 10 and Stratix V FPGAs, allowing for efficient implementation of logic functions and easy conversion of IP between the devices.

The ALM block diagram shown in the following figure has eight inputs with a fracturable look-up table (LUT), two dedicated embedded adders, and four dedicated registers.

Figure 9. Intel Stratix 10 FPGA and SoC ALM Block Diagram



Key features and capabilities of the ALM include:

- High register count with 4 registers per 8-input fracturable LUT, operating in conjunction with the new HyperFlex architecture, enables Intel Stratix 10 devices to maximize core performance at very high core logic utilization
- Implements select 7-input logic functions, all 6-input logic functions, and two independent functions consisting of smaller LUT sizes (such as two independent 4-input LUTs) to optimize core logic utilization

The Intel Quartus Prime software leverages the ALM logic structure to deliver the highest performance, optimal logic utilization, and lowest compile times. The Intel Quartus Prime software simplifies design reuse as it automatically maps legacy designs into the Intel Stratix 10 ALM architecture.

1.14. Core Clocking

Core clocking in Intel Stratix 10 devices makes use of programmable clock tree synthesis.

This technique uses dedicated clock tree routing and switching circuits, and allows the Intel Quartus Prime software to create the exact clock trees required for your design. Clock tree synthesis minimizes clock tree insertion delay, reduces dynamic power dissipation in the clock tree and allows greater clocking flexibility in the core while still maintaining backwards compatibility with legacy global and regional clocking schemes.

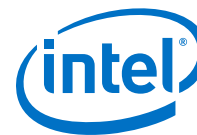
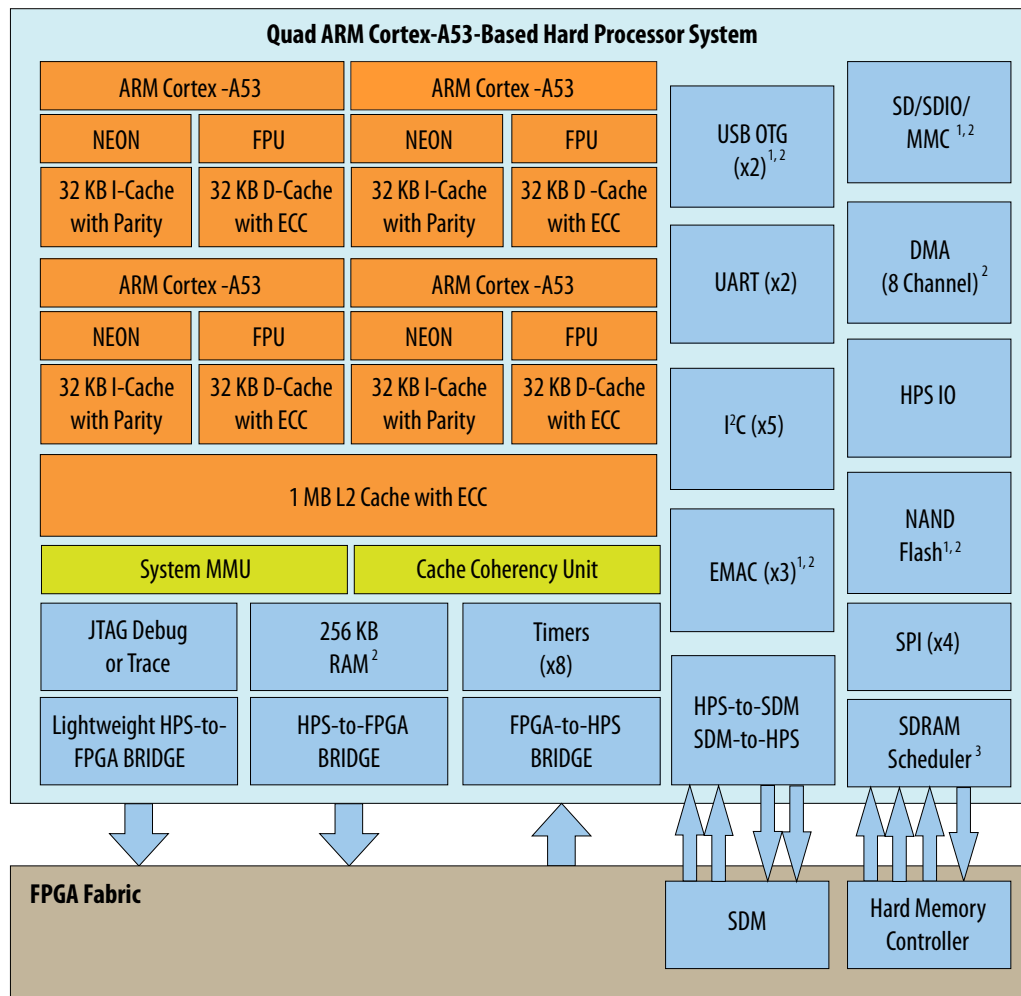


Figure 13. HPS Block Diagram



Notes:

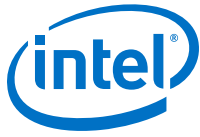
1. Integrated direct memory access (DMA)
2. Integrated error correction code (ECC)
3. Multiport front-end interface to hard memory controller

1.18.1. Key Features of the Intel Stratix 10 HPS

Table 14. Key Features of the Intel Stratix 10 GX/SX HPS

Feature	Description
Quad-core ARM Cortex-A53 MPCore processor unit	<ul style="list-style-type: none"> • 2.3 MIPS/MHz instruction efficiency • CPU frequency up to 1.5 GHz • At 1.5 GHz total performance of 13,800 MIPS • ARMv8-A architecture • Runs 64-bit and 32-bit ARM instructions • 16-bit and 32-bit Thumb instructions for 30% reduction in memory footprint • Jazelle® RCT execution architecture with 8-bit Java bytecodes

continued...



Feature	Description
	<ul style="list-style-type: none"> Superscalar, variable length, out-of-order pipeline with dynamic branch prediction Improved ARM NEON™ media processing engine Single- and double-precision floating-point unit CoreSight™ debug and trace technology
System Memory Management Unit	<ul style="list-style-type: none"> Enables a unified memory model and extends hardware virtualization into peripherals implemented in the FPGA fabric
Cache Coherency unit	<ul style="list-style-type: none"> Changes in shared data stored in cache are propagated throughout the system providing bi-directional coherency for co-processing elements.
Cache	<ul style="list-style-type: none"> L1 Cache <ul style="list-style-type: none"> 32 KB of instruction cache w/ parity check 32 KB of L1 data cache w /ECC Parity checking L2 Cache <ul style="list-style-type: none"> 1MB shared 8-way set associative SEU Protection with parity on TAG ram and ECC on data RAM Cache lockdown support
On-Chip Memory	<ul style="list-style-type: none"> 256 KB of scratch on-chip RAM
External SDRAM and Flash Memory Interfaces for HPS	<ul style="list-style-type: none"> Hard memory controller with support for DDR4, DDR3, LPDDR3 <ul style="list-style-type: none"> 40-bit (32-bit + 8-bit ECC) with select packages supporting 72-bit (64-bit + 8-bit ECC) Support for up to 2666 Mbps DDR4 and 2166 Mbps DDR3 frequencies Error correction code (ECC) support including calculation, error correction, write-back correction, and error counters Software Configurable Priority Scheduling on individual SDRAM bursts Fully programmable timing parameter support for all JEDEC-specified timing parameters Multiport front-end (MPFE) scheduler interface to the hard memory controller, which supports the AXI® Quality of Service (QoS) for interface to the FPGA fabric NAND flash controller <ul style="list-style-type: none"> ONFI 1.0 Integrated descriptor based with DMA Programmable hardware ECC support Support for 8- and 16-bit Flash devices Secure Digital SD/SDIO/MMC controller <ul style="list-style-type: none"> eMMC 4.5 Integrated descriptor based DMA CE-ATA digital commands supported 50 MHz operating frequency Direct memory access (DMA) controller <ul style="list-style-type: none"> 8-channel Supports up to 32 peripheral handshake interface

continued...



1.19. Power Management

Intel Stratix 10 devices leverage the advanced Intel 14-nm Tri-Gate process technology, the all new HyperFlex core architecture to enable Hyper-Folding, power gating, and several optional power reduction techniques to reduce total power consumption by as much as 70% compared to previous generation high-performance Stratix V devices.

Intel Stratix 10 standard power devices (-V) are SmartVID devices. The core voltage supplies (VCC and VCCP) for each SmartVID device must be driven by a PMBus voltage regulator dedicated to that Intel Stratix 10 device. Use of a PMBus voltage regulator for each SmartVID (-V) device is mandatory; it is not an option. A code is programmed into each SmartVID device during manufacturing that allows the PMBus voltage regulator to operate at the optimum core voltage to meet the device performance specifications.

With the new HyperFlex core architecture, designs can run 2X faster than previous generation FPGAs. With 2X performance and same required throughput, architects can cut the data path width in half to save power. This optimization is called Hyper-Folding. Additionally, power gating reduces static power of unused resources in the FPGA by powering them down. The Intel Quartus Prime software automatically powers down specific unused resource blocks such as DSP and M20K blocks, at configuration time.

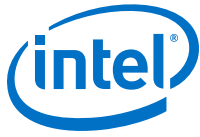
The optional power reduction techniques in Intel Stratix 10 devices include:

- **Available Low Static Power Devices**—Intel Stratix 10 devices are available with a fixed core voltage that provides lower static power than the SmartVID standard power devices, while maintaining device performance

Furthermore, Intel Stratix 10 devices feature Intel's industry-leading low power transceivers and include a number of hard IP blocks that not only reduce logic resources but also deliver substantial power savings compared to soft implementations. In general, hard IP blocks consume up to 50% less power than the equivalent soft logic implementations.

1.20. Device Configuration and Secure Device Manager (SDM)

All Intel Stratix 10 devices contain a Secure Device Manager (SDM), which is a dedicated triple-redundant processor that serves as the point of entry into the device for all JTAG and configuration commands. The SDM also bootstraps the HPS in SoC devices ensuring that the HPS can boot using the same security features that the FPGA devices have.



The SDM enables robust, secure, fully-authenticated device configuration. It also allows for customization of the configuration scheme, which can enhance device security. For configuration and reconfiguration, this approach offers a variety of advantages:

- Dedicated secure configuration manager
- Reduced device configuration time, because sectors are configured in parallel
- Updateable configuration process
- Reconfiguration of one or more sectors independent of all other sectors
- Zeroization of individual sectors or the complete device

The SDM also provides additional capabilities such as register state readback and writeback to support ASIC prototyping and other applications.

1.21. Device Security

Building on top of the robust security features present in the previous generation devices, Intel Stratix 10 FPGAs and SoCs include a number of new and innovative security enhancements. These features are also managed by the SDM, tightly coupling device configuration and reconfiguration with encryption, authentication, key storage and anti-tamper services.

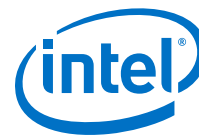
Security services provided by the SDM include:

- Bitstream encryption
- Multi-factor authentication
- Hard encryption and authentication acceleration; AES-256, SHA-256/384, ECDSA-256/384
- Volatile and non-volatile encryption key storage and management
- Boot code authentication for the HPS
- Physically Unclonable Function (PUF) service
- Updateable configuration process
- Secure device maintenance and upgrade functions
- Side channel attack protection
- Scripted response to sensor inputs and security attacks, including selective sector zeroization
- Readback, JTAG and test mode disable
- Enhanced response to single-event upsets (SEU)

The SDM and associated security services provide a robust, multi-layered security solution for your Intel Stratix 10 design.

1.22. Configuration via Protocol Using PCI Express

Configuration via protocol using PCI Express allows the FPGA to be configured across the PCI Express bus, simplifying the board layout and increasing system integration. Making use of the embedded PCI Express hard IP operating in autonomous mode before the FPGA is configured, this technique allows the PCI Express bus to be



powered up and active within the 100 ms time allowed by the PCI Express specification. Intel Stratix 10 devices also support partial reconfiguration across the PCI Express bus which reduces system down time by keeping the PCI Express link active while the device is being reconfigured.

1.23. Partial and Dynamic Reconfiguration

Partial reconfiguration allows you to reconfigure part of the FPGA while other sections continue running. This capability is required in systems where uptime is critical, because it allows you to make updates or adjust functionality without disrupting services.

In addition to lowering power and cost, partial reconfiguration also increases the effective logic density by removing the necessity to place in the FPGA those functions that do not operate simultaneously. Instead, these functions can be stored in external memory and loaded as needed. This reduces the size of the required FPGA by allowing multiple applications on a single FPGA, saving board space and reducing power. The partial reconfiguration process is built on top of the proven incremental compile design flow in the Intel Quartus Prime design software

Dynamic reconfiguration in Intel Stratix 10 devices allows transceiver data rates, protocols and analog settings to be changed dynamically on a channel-by-channel basis while maintaining data transfer on adjacent transceiver channels. Dynamic reconfiguration is ideal for applications that require on-the-fly multiprotocol or multi-rate support. Both the PMA and PCS blocks within the transceiver can be reconfigured using this technique. Dynamic reconfiguration of the transceivers can be used in conjunction with partial reconfiguration of the FPGA to enable partial reconfiguration of both core and transceivers simultaneously.

1.24. Fast Forward Compile

The innovative Fast Forward Compile feature in the Intel Quartus Prime software identifies performance bottlenecks in your design and provides detailed, step-by-step performance improvement recommendations that you can then implement. The Compiler reports estimates of the maximum operating frequency that can be achieved by applying the recommendations. As part of the new Hyper-Aware design flow, Fast Forward Compile maximizes the performance of your Intel Stratix 10 design and achieves rapid timing closure.

Previously, this type of optimization required multiple time-consuming design iterations, including full design re-compilation to determine the effectiveness of the changes. Fast Forward Compile enables you to make better decisions about where to focus your optimization efforts, and how to increase your design performance and throughput. This technique removes much of the guesswork of performance exploration, resulting in fewer design iterations and as much as 2X core performance gains for Intel Stratix 10 designs.

1.25. Single Event Upset (SEU) Error Detection and Correction

Intel Stratix 10 FPGAs and SoCs offer robust SEU error detection and correction circuitry. The detection and correction circuitry includes protection for Configuration RAM (CRAM) programming bits and user memories. The CRAM is protected by a continuously running parity checker circuit with integrated ECC that automatically corrects one or two bit errors and detects higher order multibit errors.



Document Version	Changes
	<ul style="list-style-type: none"> • Changed the features listed in the "Key Features of Stratix 10 Devices Compared to Stratix V Devices" table. • Changed the descriptions of the following areas of the "Stratix 10 FPGA and SoC Common Device Features" table: <ul style="list-style-type: none"> — Transceiver hard IP — Internal memory blocks — Core clock networks — Packaging • Reorganized and updated all tables in the "Stratix 10 FPGA and SoC Family Plan" section. • Removed the "Migration Between Arria 10 FPGAs and Stratix 10 FPGAs" section. • Removed footnotes from the "Transceiver PCS Features" table. • Changed the HMC description in the "External Memory and General Purpose I/O" section. • Changed the number of fPLLs in the "Fractional Synthesis PLLs and I/O PLLs" section. • Clarified HMC data width support in the "Key Features of the Stratix 10 HPS" table. • Changed the description in the "Internal Embedded Memory" section. • Changed the datarate for the Standard PCS and SDI PCS features in the "Transceiver PCS Features" table. • Added a note to the "PCI Express Gen1/Gen2/Gen3 Hard IP" section. • Updated the "Key Features of the Stratix 10 HPS" table. • Changed the description for the Cache coherency unit in the "Key Features of the Stratix 10 HPS" table. • Changed the description for the external SDRAM and Flash memory interfaces for HPS in the "Key Features of the Stratix 10 HPS" table.
2015.12.04	Initial release.